SQJ180EP

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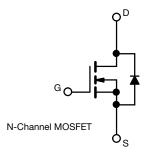
Automotive N-Channel 80 V (D-S) 175 °C MOSFET



| PRODUCT SUMMARY | |
|--|----------------|
| V _{DS} (V) | 80 |
| $R_{DS(on)} (\Omega)$ at $V_{GS} = 10 V$ | 0.0030 |
| I _D (A) | 248 |
| Configuration | Single |
| Package | PowerPAK SO-8L |

FEATURES

- TrenchFET[®] Gen IV power MOSFET
- AEC-Q101 qualified
- 100 % R_q and UIS tested
- Q_{gd}/Q_{gs} ratio < 1 optimizes switching characteristics
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>



| ABSOLUTE MAXIMUM RATING | S (T _C = 25 °C, unless | s otherwise noted | i) | |
|---|--|-----------------------------------|-------------|------|
| PARAMETER | | SYMBOL | LIMIT | UNIT |
| Drain-source voltage | | V _{DS} | 80 | v |
| Gate-source voltage | | V _{GS} | ± 20 | V |
| Continuous drain current | T _C = 25 °C | I | 248 | |
| Continuous drain current | T _C = 125 °C | I _D | 143 | |
| Continuous source current (diode conduction) | | I _S | 248 | A |
| Pulsed drain current | | I _{DM} | 420 | |
| Single pulse avalanche current | L = 0.1 mH | I _{AS} | 42 | |
| Single pulse avalanche energy | | E _{AS} | 88 | mJ |
| Maximum power dissipation | T _C = 25 °C | Р | 500 | w |
| Maximum power dissipation | T _C = 125 °C | P _D | 166 | vv |
| Operating junction and storage temperature | erange | T _J , T _{stg} | -55 to +175 | °C |
| Soldering recommendations (peak temperature) ^b | | | 260 | |

| THERMAL RESISTANCE RATINGS | | | | |
|----------------------------|------------------------|-------------------|-------|------|
| PARAMETER | | SYMBOL | LIMIT | UNIT |
| Junction-to-ambient | PCB mount ^a | R _{thJA} | 42 | °C/W |
| Junction-to-case (drain) | | R _{thJC} | 0.3 | 0/W |

Notes

a. When mounted on 1" square PCB (FR4 material)

b. See solder profile (<u>www.vishay.com/doc?73257</u>). The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection

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| SPECIFICATIONS ($T_C = 25 \ ^{\circ}C$, | unless otherv | vise noted) | | | | | | |
|--|--------------------------|--|---|------|--------|--------|------|--|
| PARAMETER | SYMBOL | TES | T CONDITIONS | MIN. | TYP. | MAX. | UNIT | |
| Static | • | • | | • | | • | | |
| Drain-source breakdown voltage | V _{DS} | $V_{GS} = 0, I_D = 250 \ \mu A$ | | 80 | - | - | v | |
| Gate-source threshold voltage | V _{GS(th)} | V _{DS} = | = V _{GS} , I _D = 250 μΑ | 2.2 | 2.7 | 3.5 | v | |
| Gate-source leakage | I _{GSS} | V _{DS} = | : 0 V, V _{GS} = ± 20 V | - | - | ± 100 | nA | |
| | | $V_{GS} = 0 V$ | V _{DS} = 80 V | - | - | 10 | | |
| Zero gate voltage drain current | I _{DSS} | $V_{GS} = 0 V$ | $V_{DS} = 80 \text{ V}, \text{ T}_{J} = 125 ^{\circ}\text{C}$ | - | - | 50 | μA | |
| | | $V_{GS} = 0 V$ | V _{DS} = 80 V, T _J = 175 °C | - | - | 250 | | |
| On-state drain current ^a | I _{D(on)} | $V_{GS} = 10 V$ | $V_{DS} \ge 5 V$ | 30 | - | - | Α | |
| | | $V_{GS} = 10 V$ | I _D = 15 A | - | 0.0025 | 0.0030 | | |
| Drain-source on-state resistance ^a | R _{DS(on)} | $V_{GS} = 10 V$ | I _D = 15 A, T _J = 125 °C | - | - | 0.0059 | Ω | |
| | | $V_{GS} = 10 V$ | I _D = 15 A, T _J = 175 °C | - | - | 0.0075 | | |
| Forward transconductance ^b | 9 _{fs} | V _{DS} | = 15 V, I _D = 10 A | - | 82 | - | S | |
| Dynamic ^b | | | | | | | | |
| Input capacitance | C _{iss} | | V _{DS} = 25 V, f = 1 MHz | - | 4746 | 6645 | pF | |
| Output capacitance | C _{oss} | $V_{GS} = 0 V$ | | - | 814 | 1140 | | |
| Reverse transfer capacitance | C _{rss} | | | - | 51 | 72 | | |
| Total gate charge ^c | Qg | | | - | 78 | 117 | | |
| Gate-source charge ^c | Q _{gs} | $V_{GS} = 10 V$ | $V_{DS} = 40 \text{ V}, I_{D} = 10 \text{ A}$ | - | 18 | - | nC | |
| Gate-drain charge ^c | Q _{gd} | | | - | 16 | - | | |
| Gate resistance | R _g | | f = 1 MHz | 0.5 | 1.0 | 1.50 | Ω | |
| Turn-on delay time ^c | t _{d(on)} | | | - | 16 | 20 | | |
| Rise time ^c | t _r | V _{DD} | = 40 V, $R_L = 4 \Omega$ | - | 10 | 15 | | |
| Turn-off delay time ^c | t _{d(off)} | $I_D \cong 10$ Å, $V_{GEN} = 10$ V, $R_g = 1$ Ω | | - | 39 | 50 | ns | |
| Fall time ^c | t _f | | | | 9 | 15 | | |
| Source-Drain Diode Ratings and Chara | acteristics ^b | | | | | | | |
| Pulsed current ^a | I _{SM} | | | | - | 420 | Α | |
| Forward voltage | V _{SD} | I _F = 15 A, V _{GS} = 0 V | | - | - | 1.1 | V | |
| Body diode reverse recovery time | t _{rr} | I _F = 10 A, di/dt = 100 A/μs | | - | 50 | 65 | ns | |
| Body diode reverse recovery charge | Q _{rr} | | | - | 71 | 95 | nC | |
| Reverse recovery fall time | t _a | | | - | 28 | 44 | ns | |
| Reverse recovery rise time | t _b | | - | 22 | 38 | | | |
| Body diode peak reverse recovery current | I _{RM(REC)} | | | - | 2.4 | 3.6 | А | |

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %

b. Guaranteed by design, not subject to production testing

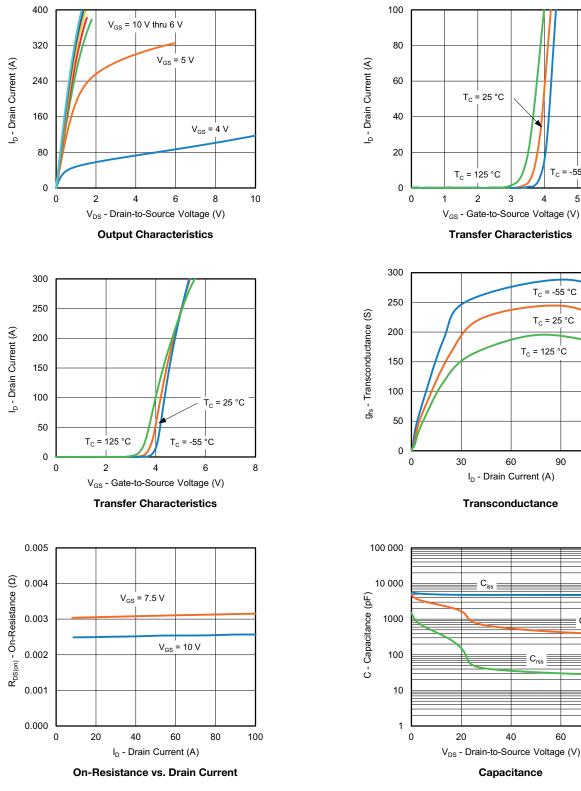
c. Independent of operating temperature

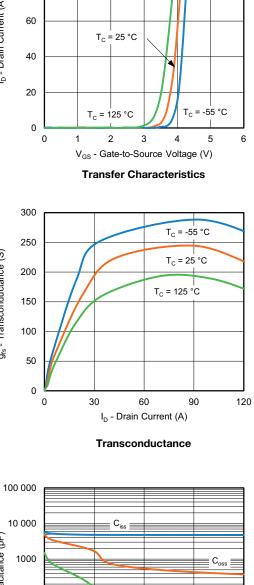
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

2



TYPICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$, unless otherwise noted)





 C_{rss}

60

40

Capacitance

3

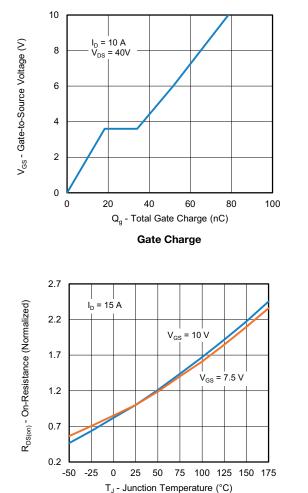
80

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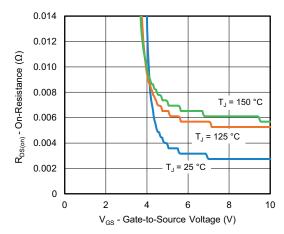


100 125 150 175

TYPICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$, unless otherwise noted)

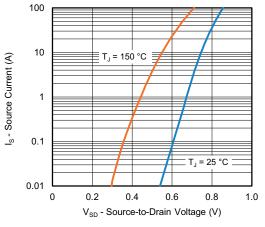


On-Resistance vs. Junction Temperature



On-Resistance vs. Gate-to Source Voltage

4



T_{.I} - Junction Temperature (°C)

Drain Source Breakdown vs. Junction Temperature

100

97

94

91

88

85

82

-50 -25 0 25 50 75

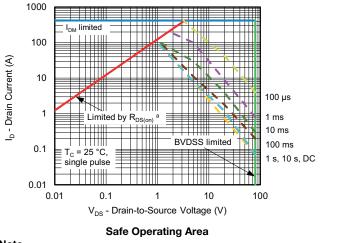
V_{DS} - Drain-to-Source Voltage (V)

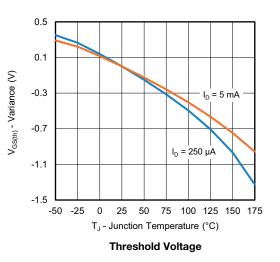
 $I_D = 1 \text{ mA}$

Source Drain Diode Forward Voltage



TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)





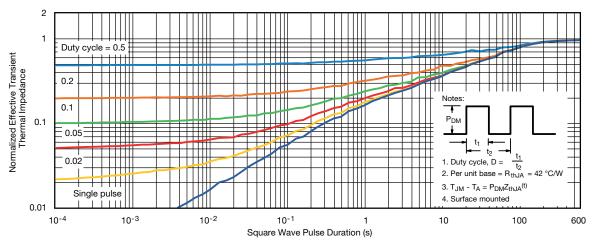
Note

a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

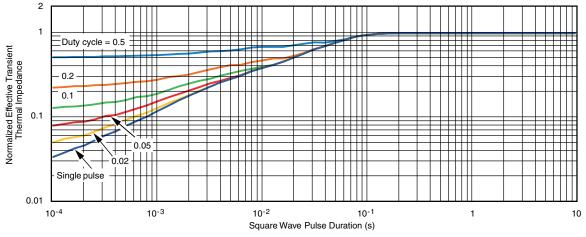
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TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

Note

• The characteristics shown in the two graphs

- Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)

- Normalized Transient Thermal Impedance Junction-to-Case (25 °C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions

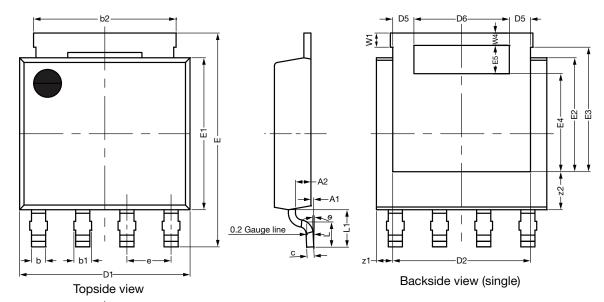
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| S21-0368-Rev. B, 19-Apr-2021 | 6 | Document Number: 77297 |
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PowerPAK[®] SO-8L Case Outline 3



| 514 | | MILLIMETERS | | | INCHES | | | |
|--------------------------------|-------------|-------------|-------|-----------|--------|-------|--|--|
| DIM. | MIN. | MIN. NOM. | | MIN. | NOM. | MAX. | | |
| А | 1.00 | 1.05 | 1.10 | 0.039 | 0.041 | 0.043 | | |
| A1 | 0.00 | | 0.127 | 0.000 | | 0.005 | | |
| A2 | 0.40 | 0.45 | 0.50 | 0.016 | 0.018 | 0.020 | | |
| b | 0.33 | 0.41 | 0.49 | 0.013 | 0.016 | 0.019 | | |
| b1 | 0.43 | 0.51 | 0.59 | 0.017 | 0.020 | 0.023 | | |
| b2 | 4.00 | 4.10 | 4.20 | 0.157 | 0.161 | 0.165 | | |
| С | 0.15 | 0.20 | 0.25 | 0.006 | 0.008 | 0.010 | | |
| D1 | 4.80 | 4.90 | 5.00 | 0.189 | 0.193 | 0.197 | | |
| D2 | 3.86 | 3.96 | 4.06 | 0.152 | 0.156 | 0.160 | | |
| D5 | 0.51 | 0.61 | 0.71 | 0.020 | 0.024 | 0.028 | | |
| D6 | 2.64 | 2.74 | 2.84 | 0.104 | 0.108 | 0.112 | | |
| е | | 1.27 BSC | | 0.050 BSC | | | | |
| E | 6.05 | 6.15 | 6.25 | 0.238 | 0.242 | 0.246 | | |
| E1 | 4.27 | 4.37 | 4.47 | 0.168 | 0.172 | 0.176 | | |
| E2 | 3.18 | 3.28 | 3.38 | 0.125 | 0.129 | 0.133 | | |
| E3 | 3.48 | 3.58 | 3.68 | 0.137 | 0.141 | 0.145 | | |
| E4 | 2.72 | 2.82 | 2.92 | 0.107 | 0.111 | 0.115 | | |
| E5 | 0.71 | 0.81 | 0.91 | 0.028 | 0.032 | 0.036 | | |
| L | 0.62 | 0.72 | 0.82 | 0.024 | 0.028 | 0.032 | | |
| L1 | 0.92 | 1.07 | 1.22 | 0.036 | 0.042 | 0.048 | | |
| W1 | 0.31 | 0.41 | 0.51 | 0.012 | 0.016 | 0.020 | | |
| W4 | 0.31 | 0.36 | 0.41 | 0.012 | 0.014 | 0.016 | | |
| z1 | 0.37 | 0.47 | 0.57 | 0.015 | 0.019 | 0.022 | | |
| z2 | 0.99 | 1.09 | 1.19 | 0.039 | 0.043 | 0.047 | | |
| θ | 0° | | 5° | 0° | | 5° | | |
| l: S19-0643-Rev. B, G: 6067 | 05-Aug-2019 | | | | | | | |

Note

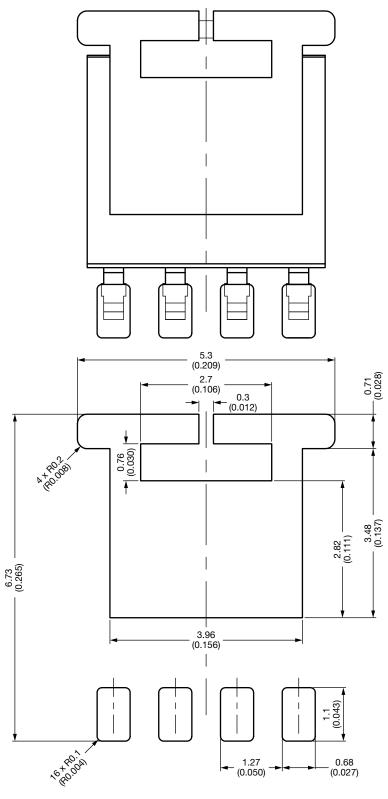
• Millimeter will govern

Revison: 05-Aug-2019

Document Number: 76666



Recommended Land Pattern PowerPAK® SO-8L Single Short Ear



Dimensions in Millimeters (Inches)

Revision: 24-Aug-2021



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